

Spokane, WA, USA - 13 September 2018

Name	Employer	Affiliation
Anslow, Peter	Ciena	Ciena Corporation
Baggett, Tim	Microchip Technology, Inc.	Microchip Technology, Inc.
Bains, Amrik	Cisco Systems, Inc.	Cisco Systems, Inc.
Baumgartner, Steven	GLOBALFOUNDRIES	GLOBALFOUNDRIES
Beruto, Piergiorgio	Canova Tech S.r.l.	Canova Tech Srl
Bhagwat, Gitesh		Analog Devices Inc.
Bouda, Martin	Fujitsu Laboratories of America, Inc.	Fujitsu Laboratories of America, Inc.
Brandt, David	Rockwell Automation	Rockwell Automation
Braun, Ralf-Peter	Deutsche Telekom AG	Deutsche Telekom AG
Brychta, Michal	Analog Devices Inc.	Analog Devices Inc.
Burrell, Gary	Elenion Technologies	Elenion Technologies
Butter, Adrian	GLOBALFOUNDRIES	GLOBALFOUNDRIES
Carlson, Steven	High-Speed Design Inc.	Robert Bosch GmbH
Chalupsky, David	Intel Corporation	Intel Corporation
Chattopadhyay, Biman		Synopsys, Inc.
Choudhury, Golam	OFS	OFS
D'Ambrosia, John	Futurewei Technologies	Futurewei (Subsidiary of Huawei)
Dawe, Piers J G	Mellanox Technologies	Mellanox Technologies
den Besten, Gerrit	NXP Semiconductors	NXP Semiconductors
DeSanti, Claudio	Google	Google
Diminico, Christopher	M C Communications, LLC	Panduit Corp.
Djahanshahi, Hormoz	Microsemi Corporation	Microsemi Corporation
Donahue, Curtis	University of New Hampshire	UNH-IOL
Dube, Kathryn	UNH-IOL	UNH-IOL
Dudek, Michael	Marvell	Marvell
Effenberger, Frank	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd
Fathi Moghadam, Borhan	NVIDIA Corporation	NVIDIA Corporation
Franchuk, Brian	Emerson Automation Solutions	Emerson Automation Solutions
Fritsche, Matthias	HARTING Technologie Gruppe	HARTING Electronics GmbH
Gorshe, Steven Scott	Microchip Technology, Inc.	Microchip Technology, Inc.
Gottron, Jens	Siemens AG	Siemens AG
Graber, Steffen	Pepperl+Fuchs GmbH	Pepperl+Fuchs GmbH
Grow, Robert	RMG Consulting	RMG Consulting
Gustlin, Mark	Xilinx Inc	Xilinx
Hajduczenia, Marek	Charter Communications	Charter Communications
Healey, Adam	Broadcom Inc.	Broadcom Inc.
Heck, Howard	Intel Corporation	Intel Corporation
Holden, Brian	Kandou Bus	Kandou Bus
Horner, Rita	Synopsys, Inc.	Synopsys, Inc.
Huszak, Gergely	Self	Kone
ingrassia, alessandro	canova tech	canova tech
Johnson, John	Broadcom Limited	Broadcom Limited

Spokane, WA, USA - 13 September 2018

Name	Employer	Affiliation
Jones, Chad	Cisco Systems, Inc.	Cisco Systems, Inc.
Jones, Peter	Cisco Systems, Inc.	Cisco Systems, Inc.
Kimber, Eric	Semtech Ltd	Semtech Ltd
Kochuparambil, Elizabeth	Cisco Systems, Inc.	Cisco Systems, Inc.
Lackner, Hans	QoSCom GmbH	QoSCom - Quality in
Laubach, Mark	Broadcom Corporation	Broadcom Corporation
Law, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise
Lawlis, James	Ford Motor Company	Ford Motor Company
Lewis, Jon	Dell EMC	Dell EMC
Lu, Yuchun	Huawei Technologies Co. Ltd	HUAWEI
Lusted, Kent	Intel Corporation	Intel Corporation
Maguire, Valerie	The Siemon Company	The Siemon Company
Maki, Jeffery	Juniper Networks, Inc.	Juniper Networks, Inc.
Malicoat, David	Malicoat Networking Solutions	Aquantia; SENKO Advanced
Mcclellan, Brett	Marvell Semiconductor, Inc.	Marvell Semiconductor, Inc.
McMillan, Larry	Western Digital Corporation	Western Digital Corporation
Nicholl, Shawn	Xilinx	Xilinx
Nowell, Mark	Cisco Systems, Inc.	Cisco Systems, Inc.
Ofelt, David	Juniper Networks, Inc.	Juniper Networks, Inc.
Pardo, Carlos	Knowledge Development for POF SL	KDPOF
Ran, Adee	Intel Corporation	Intel Corporation
Rechtman, Zvi	Mellanox Technologies	Mellanox Technologies
Remein, Duane	Futurewei Technologies	Huawei Technologies Co. Ltd
Rotolo, Salvatore	STMicroelectronics	STMicroelectronics
Sakai, Toshiaki	Socionext	socionext
Shariff, Masood	CommScope, Inc.	CommScope, Inc.
Slavick, Jeff	Broadcom Inc	Broadcom
Stassar, Peter	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd
Stewart, Heath	Analog Devices Inc.	Analog Devices Inc.
Thompson, Geoffrey	GraCaSI S.A.	INDEPENDENT
Tracy, Nathan	TE Connectivity	TE Connectivity
Tremblay, David	Hewlett Packard Enterprise	Hewlett Packard Enterprise
Trowbridge, Stephen	Nokia	Nokia
Voss, Robert	Panduit Corp.	Panduit Corp.
Wang, Xinyuan	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd
Wey, Jun Shan	ZTE TX Inc	ZTE Corporation
Widger, Madelyn		University of New Hampshire InterOperability Laboratory (UNH- IOL)
Withey, James	Fluke Corporation	Fluke Corporation
Xu, Yu	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd
Young, James	CommScope, Inc.	CommScope

Spokane, WA, USA - 13 September 2018

Name	Employer	Affiliation
Zambell, Andrew	Amphenol Corporation	Amphenol Corporation
Zhou, Richard (Yujia)	Charter Communications	Charter Communications
Zhuang, Yan	Huawei Technologies Co. Ltd	Huawei Technologies Co. Ltd
Zielinski, Martin	Emerson Electric Co.	Emerson Process Management
Zivny, Pavel	Tektronix, Inc.	Tektronix, Inc.